

N-Channel Enhancement-Mode MOSFET Transistors

TN2410L VN2406D VN2410L
VN2406L VN2410M
VN2406M

Product Summary

Part Number	$V_{(BR)DSS}$ Min (V)	$r_{DS(on)}$ Max (Ω)	$V_{GS(th)}$ (V)	I_D (A)
TN2410L	240	10 @ $V_{GS} = 4.5$ V	0.5 to 1.8	0.18
VN2406D		6 @ $V_{GS} = 10$ V	0.8 to 2	1.12
VN2406L		6 @ $V_{GS} = 10$ V	0.8 to 2	0.18
VN2406M		6 @ $V_{GS} = 10$ V	0.8 to 2	0.19
VN2410L		10 @ $V_{GS} = 10$ V	0.8 to 2	0.18
VN2410M		10 @ $V_{GS} = 10$ V	0.8 to 2	0.19

Features

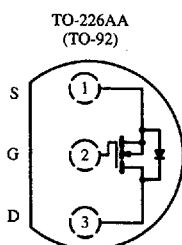
- Low On-Resistance: 3.5 Ω
- Secondary Breakdown Free: 260 V
- Low Power/Voltage Driven
- Low Input and Output Leakage
- Excellent Thermal Stability

Benefits

- Low Offset Voltage
- Full-Voltage Operation
- Easily Driven Without Buffer
- Low Error Voltage
- No High-Temperature "Run-Away"

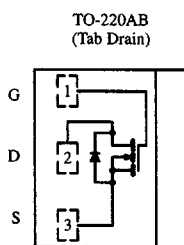
Applications

- High-Voltage Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Transistors, etc.
- Telephone Mute Switches, Ringer Circuits
- Power Supply, Converters
- Motor Control



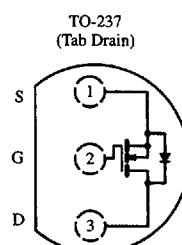
Top View

TN2410L
VN2406L
VN2410L



Top View

VN2406D



Top View

VN2406M
VN2410M

Updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70204.

Siliconix

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TN2410L, VN2406/2410 Series

TEMIC
Semiconductors

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	TN2410L	VN2406D ^b	VN2406L	VN2406M	VN2410L	VN2410M	Unit
Drain-Source Voltage	V_{DS}	240	240	240	240	240	240	V
Gate-Source Voltage	V_{GS}	± 20	± 20	± 20	± 20	± 20	± 20	
Continuous Drain Current ($T_J = 150^\circ\text{C}$)	I_D	$T_A = 25^\circ\text{C}$	0.18	1.12	0.18	0.19	0.18	A
		$T_A = 100^\circ\text{C}$	0.11	0.7	0.11	0.12	0.11	
Pulsed Drain Current ^a	I_{DM}	1	3	1.7	2	1.7	2	
Power Dissipation	P_D	$T_A = 25^\circ\text{C}$	0.8	20	0.8	1	0.8	W
		$T_A = 100^\circ\text{C}$	0.32	8	0.32	0.4	0.32	
Maximum Junction-to-Ambient	R_{thJA}	156	6.25 ^c	156	125	156	125	$^\circ\text{C/W}$
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150						$^\circ\text{C}$

Notes

- a. Pulse width limited by maximum junction temperature.
b. Reference case for all temperature testing.
c. Maximum junction-to-case

Specifications^a

Parameter	Symbol	Test Conditions	Typ ^b	Limits						Unit
				TN2410L		VN2406D/L/M		VN2410L/M		
				Min	Max	Min	Max	Min	Max	
Static										
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 100 μA	260	240		240		240		V
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 1 mA	1.4	0.5	1.8	0.8	2	0.8	2	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 15 V					± 100		± 10 0	nA
		T _J = 125°C				± 500		± 50 0		
		V _{DS} = 0 V, V _{GS} = ± 20 V			± 10					
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 192 V, V _{GS} = 0 V	0.01		1					μA
		T _J = 125°C	1		100					
		V _{DS} = 120 V, V _{GS} = 0 V					10		10	
		T _J = 125°C					500		500	
On-State Drain Current ^c	I _{D(on)}	V _{DS} = 10 V, V _{GS} = 4.5 V	0.8	0.25						A
		V _{DS} = 15 V, V _{GS} = 10 V	1.5			1		1		
Drain-Source On-Resistance ^c	r _{DS(on)}	V _{GS} = 2.5 V, I _D = 0.1 A	7.5				10		10	Ω
		V _{GS} = 3.5 V, I _D = 0.05 A	4.5		15					
		V _{GS} = 4.5 V, I _D = 0.2 A	4		10					
		T _J = 125°C	7.5		20					
		V _{GS} = 10 V, I _D = 0.5 A	3.5				6		10	
		T _J = 125°C	6.5				14.8		24.7	
Forward Transconductance ^c	g _{fs}	V _{DS} = 10 V, I _D = 0.2 A	500	100						mS
		V _{DS} = 10 V, I _D = 0.5 A	530			300		300		

Specifications^a

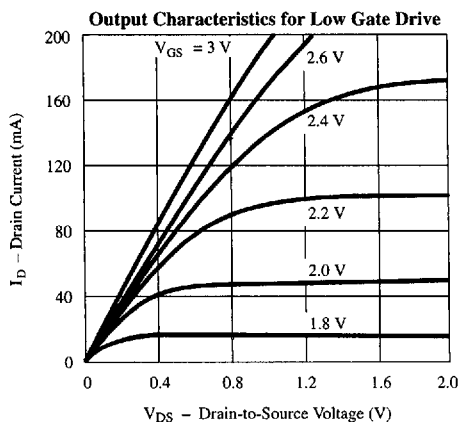
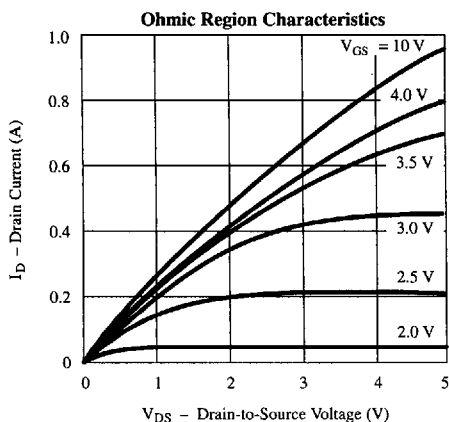
Parameter	Symbol	Test Conditions	Typ ^b	Limits						Unit
				TN2410L		VN2406D/L/M		VN2410L/M		
				Min	Max	Min	Max	Min	Max	
Dynamic										
Input Capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V f = 1 MHz	115		135		135		135	pF
Output Capacitance	C _{oss}		30		50		50		50	
Reverse Transfer Capacitance	C _{rss}		5		20		20		20	
Switching ^d										
Turn-On Time	t _{ON}	V _{DD} = 60 V, R _L = 150 Ω I _D ≅ 0.4 A, V _{GEN} = 10 V R _G = 25 Ω	5		35					ns
	t _{d(on)}		3				8		8	
	t _r		2				8		8	
Turn-Off Time	t _{OFF}		26		60					
	t _{d(off)}		20				23		23	
	t _f		6				24		34	

Notes

- $T_A = 25^\circ\text{C}$ unless otherwise noted.
- For DESIGN AID ONLY, not subject to production testing.
- Pulse test: $PW \leq 300\ \mu\text{s}$ duty cycle $\leq 2\%$.
- Switching time is essentially independent of operating temperature.

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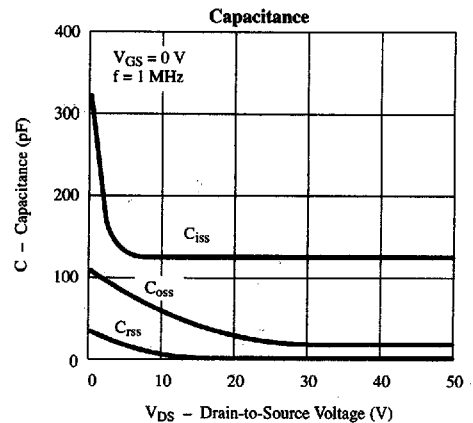
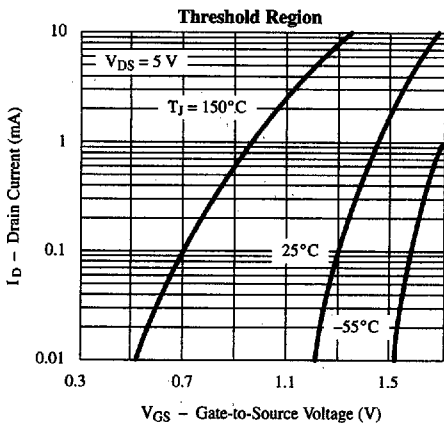
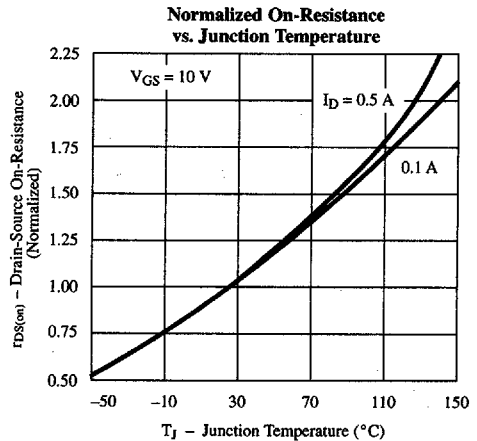
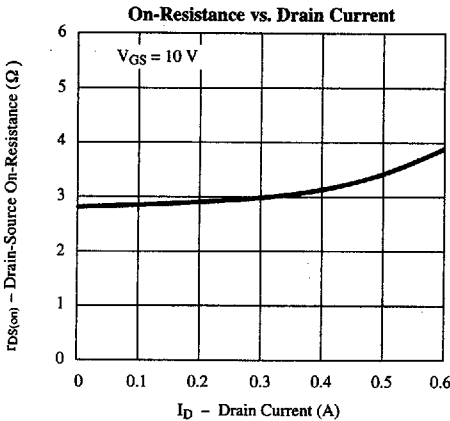
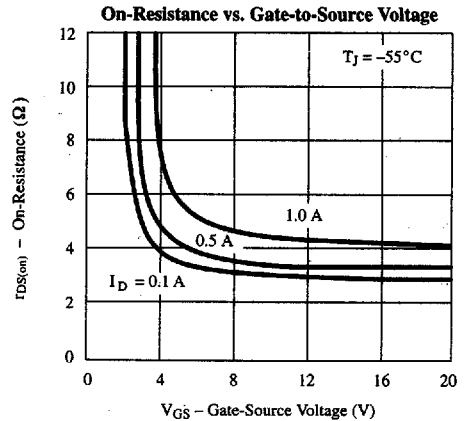
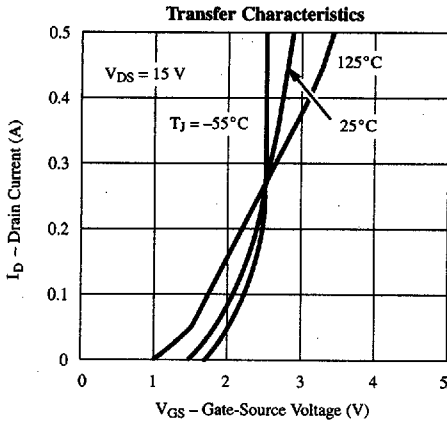
Typical Characteristics (25°C Unless Otherwise Noted)



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Low Power MOSFETs

Typical Characteristics (25°C Unless Otherwise Noted) (Cont'd)



Typical Characteristics (25°C Unless Otherwise Noted) (Cont'd)

